

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L4	7156	"adhesion promoter"	US-PGPUB; USPAT	OR	OFF	2005/02/15 11:01
L5	4433	porous with dielectric	US-PGPUB; USPAT	OR	OFF	2005/02/15 11:01
L6	33083	SILK	US-PGPUB; USPAT	OR	OFF	2005/02/15 11:02
L7	99	4 and 5	US-PGPUB; USPAT	OR	OFF	2005/02/15 11:02
S1	3002	"porous silicon"	US-PGPUB; USPAT	OR	OFF	2005/02/08 13:10
S2	9811	damascene	US-PGPUB; USPAT	OR	OFF	2005/02/08 13:10
S3	164	S1 and S2	US-PGPUB; USPAT	OR	OFF	2005/02/08 13:10
S4	1188063	@ad>"20000727" or @rlad>"20000727"	US-PGPUB; USPAT	OR	OFF	2005/02/08 13:12
S5	41	S3 not S4	US-PGPUB; USPAT	OR	OFF	2005/02/08 13:12
S6	2810	"silicon dioxide" with barrier	US-PGPUB; USPAT	OR	OFF	2005/02/11 09:58
S7	818	(438/627).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/02/11 09:58
S8	2166	(438/637).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/02/11 09:58
S9	262	(438/628).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/02/11 09:58
S10	915	(438/643).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/02/11 09:59
S11	266	(438/644).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/02/11 09:59
S12	3010	"porous silicon"	US-PGPUB; USPAT	OR	OFF	2005/02/11 09:59
S13	1194026	@ad>"20000727" or @rlad>"20000727"	US-PGPUB; USPAT	OR	OFF	2005/02/11 10:03
S14	9858	damascene	US-PGPUB; USPAT	OR	OFF	2005/02/11 09:59
S15	165	S12 and S14	US-PGPUB; USPAT	OR	OFF	2005/02/11 09:59
S16	9	S7 and S12	US-PGPUB; USPAT	OR	OFF	2005/02/11 09:59
S17	24	S8 and S12	US-PGPUB; USPAT	OR	OFF	2005/02/11 09:59
S18	2	S9 and S12	US-PGPUB; USPAT	OR	OFF	2005/02/11 09:59

S19	4	S10 and S12	US-PGPUB; USPAT	OR	OFF	2005/02/11 09:59
S20	1	S11 and S12	US-PGPUB; USPAT	OR	OFF	2005/02/11 09:59
S21	63139	swelling	US-PGPUB; USPAT	OR	OFF	2005/02/11 10:00
S22	48	RELACS	US-PGPUB; USPAT	OR	OFF	2005/02/11 10:01
S23	117	seal\$3 with pores with silicon	US-PGPUB; USPAT	OR	OFF	2005/02/11 10:01
S24	69	S23 not S13	US-PGPUB; USPAT	OR	OFF	2005/02/11 10:01
S25	0	S14 and S24	US-PGPUB; USPAT	OR	OFF	2005/02/11 10:01
S26	8	S23 and S14	US-PGPUB; USPAT	OR	OFF	2005/02/11 10:04
S27	173	seal\$3 and pores and silicon	EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/11 10:04
S28	3200	damascene	EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/11 10:04
S29	0	S27 and S28	EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/11 10:04
S30	135716	barrier	EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/11 10:05
S31	8	S27 and S30	EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/02/11 10:05
S32	1	("6734090").PN.	US-PGPUB; USPAT	OR	OFF	2005/02/11 11:45
S33	324	SILK with "dielectric constant"	US-PGPUB; USPAT	OR	OFF	2005/02/11 12:33
S34	988	swell\$3 with pores	US-PGPUB; USPAT	OR	OFF	2005/02/11 12:35
S35	0	swell\$3 with pores with dielectric	US-PGPUB; USPAT	OR	OFF	2005/02/11 12:36
S36	0	damascenen	US-PGPUB; USPAT	OR	OFF	2005/02/11 12:34
S37	9858	damascene	US-PGPUB; USPAT	OR	OFF	2005/02/11 12:34
S38	4	S34 and S37	US-PGPUB; USPAT	OR	OFF	2005/02/11 12:34

S39	6	RELACS and damascene	US-PGPUB; USPAT	OR	OFF	2005/02/11 12:35
S40	45	adhesion with pores with dielectric	US-PGPUB; USPAT	OR	OFF	2005/02/11 12:38
S41	34522	"AP 6000" or AP	US-PGPUB; USPAT	OR	OFF	2005/02/11 12:38
S42	1925	(pores or porous) and damascene	US-PGPUB; USPAT	OR	OFF	2005/02/11 12:38
S43	20	S41 and S42	US-PGPUB; USPAT	OR	OFF	2005/02/11 12:48